

# X13 SuperEdge

### High-Density Computing and Flexibility at the Intelligent Edge



## Compact yet versatile system designed for maximum performance at the Edge

- 2U Short-depth (430mm), 3-node system
- Single 5th/4th Gen Intel® Xeon® Scalable processor per node
- Front-access hot-swappable nodes
- Up to 8 DIMMs slots per node supporting DDR5-5600
- Up to 3 PCIe 5.0 slots per node
- Operating temperatures from -5°C to 55°C (CPU TDPdependent)

#### **Integrated COTS System Design**

Supermicro's X13 SuperEdge features an integrated, all-in-one Commercial Off The Shelf (COTS) server design optimized for CU/DU deployments in Open vRAN networks. With NCSI support, operators can use a single fiber connection for both data traffic and OOB management, and the integrated architecture of the 5G RAN system eliminates the need for add-on cards and breakout cables, resulting in a system that is optimized for cost, size and power usage and is able to handle immense traffic volumes at remote locations.

#### **Front Accessibility**

The X13 SuperEdge has been designed to incorporate easily into existing telco and edge data center infrastructure, with front-swappable nodes featuring front I/O making servicing in space-constrained environments simpler. Both AC and DC power supply options are also available to accommodate the constraints often encountered at remote data center locations.

#### **Short Depth for Edge Deployments**

At just 430mm in depth, the X13 SuperEdge chassis is designed to fit into space -constrained environments such as edge data centers and telco cabinets and the optimized thermal design allows maximum airflow over internal components for an ambient operating temperature range of up to -5°C to 55°C. The SuperEdge architecture has also been designed to withstand a wide range of humidity and other environmental conditions, making it suitable for deployment in harsh conditions outside of the traditional data center.

#### **Powered by 5th Gen Intel Xeon Processors**

Get data center performance at the edge with 5th Gen Intel Xeon Processors up to 300W TDP per node. The new processors are available in Edge-optimized SKUs which feature the built-in Intel vRAN Boost accelerator which can provide up to 2x vRAN capacity at the same power envelope and reduce power consumption by up to 20% on vRAN workloads.



# X13 SuperEdge

### **Multi-Node Enterprise Edge Computing**



## **Customizable 2U 4-Node System for Edge** and Telco

- Single 5th/4th Gen Intel® Xeon® Scalable processor per node
- 24 front-access 2.5" hot-swap SATA drives (6 per node)
- Up to 8 DIMMs slots per node supporting DDR5-5600Mhz
- Up to 2 PCIe 5.0 HHHL slots per node
- Operating temperatures from 0°C 35°C (32°F 95°F) (CPU TPD-dependent)

## **Data Center-Class Performance and Expandability at the Edge**

Supermicro's SuperEdge is designed to handle the increasing compute and I/O density requirements of modern 5G applications. With 4 customizable single-processor nodes, SuperEdge delivers high-class performance in a 2U chassis. Each node is hot-swappable and offers front-access storage drives, making the system ideal for remote IoT, edge, or telco deployments. Each node can accommodate two PCIe 5.0 slots, enabling a wide range of add-on cards such as FPGA, DPU, eASIC, and TimeSync cards that allow SuperEdge to be outfitted for networking.

#### **Powered by 5th Gen Intel Xeon Processors**

Get data center performance at the edge with 5th Gen Intel Xeon Processors up to 270W TDP per node. The new processors are available in Edge-optimized SKUs which feature the built-in Intel vRAN Boost accelerator which can provide up to 2x vRAN capacity at the same power envelope and reduce power consumption by up to 20% on vRAN workloads.



Front View



Rear View









SuperEdge 3-Node	SYS-211SE-31A/AS (per node)	SYS-211SE-31D/DS (per node)
Processor Support (node)	Single 5th/4th Gen Intel® Xeon® Scalable processor Up to 300W TDP (air cooled)†	Single 5th/4th Gen Intel® Xeon® Scalable processor Up to 300W TDP (air cooled)†
Memory Slots & Capacity (node)	8 DIMM slots; Up to 2TB DDR5-5600MT/s	8 DIMM slots; Up to 2TB DDR5-5600MT/s
I/O Ports (node)	1 1GbE RJ45 port (SYS-211SE-31A) 1 1GbE SFP port (SYS-211SE-31AS) 1 KVM dongle (output VGA x1, COM x1, USB 2.0 x2 through KVM cable)	1 1GbE RJ45 port (SYS-211SE-31D) 1 1GbE SFP port (SYS-211SE-31DS) 1 KVM dongle (output VGA x1, COM x1, USB 2.0 x2 through KVM cable)
Motherboard	X13SEED-F (SYS-211SE-31A) X13SEED-SF (SYS-211SE-31AS)	X13SEED-F (SYS-211SE-31D) X13SEED-SF (SYS-211SE-31DS)
Form Factor	2U Rackmount 430mm/16.9" depth	2U Rackmount 430mm/16.9" depth
Expansion Slots (node)	2 PCIe 5.0 x16 FHHL 1 PCIe 5.0 x16 LP	2 PCle 5.0 x16 FHHL 1 PCle 5.0 x16 LP
Drive Bays (node)	2 NVMe M.2 2280/22110 (per node)	2 NVMe M.2 2280/22110 (per node)
Cooling	4 heavy duty fans	4 heavy duty fans
Power	2000W AC Redundant power supplies	2000W DC Redundant power supplies

 $<sup>^\</sup>dagger\text{CPUs}$  with high TDP supported under specific conditions. Contact Technical Support for details.





SuperEdge 4-Node	SYS-211TP-HPTR (per node)	SYS-211TP-HPTRD (per node)
Processor Support (node)	Single 5th/4th Gen Intel® Xeon® Scalable processor Up to 270W TDP (air cooled)†	Single 5th/4th Gen Intel® Xeon® Scalable processor Up to 270W TDP (air cooled)†
Memory Slots & Capacity (node)	8 DIMM slots; Up to 2TB DDR5-5600MT/s	8 DIMM slots; Up to 2TB DDR5-5600MT/s
I/O Ports (node)	Dedicated IPMI LAN port 2 10GbE SFP+ ports 2 USB 3.0 Gen1 ports 1 VGA port	Dedicated IPMI LAN port 2 10GbE SFP+ ports 2 USB 3.0 Gen1 ports 1 VGA port
Motherboard	X13SET-PT	X13SET-PT
Form Factor	2U Rackmount 730mm/28.75" depth	2U Rackmount 730mm/28.75" depth
Expansion Slots (node)	2 PCle 5.0 x16 LP slots	2 PCIe 5.0 x16 LP slots
Drive Bays (node)	6 hot-swap 2.5" drive bays	6 hot-swap 2.5" drive bays
Cooling	4 heavy duty 8cm fans (per enclosure)	4 heavy duty 8cm fans (per enclosure)
Power	2000W AC Redundant power supplies (per enclosure)	2000W DC Redundant power supplies (per enclosure)

 $<sup>^\</sup>dagger\text{CPUs}$  with high TDP supported under specific conditions. Contact Technical Support for details.